# intersil

### Data Sheet

### September 15, 2015

## FN3121.9

# Dual/Quad SPST, CMOS Analog Switches

HI-200/HI-201 (dual/quad) are monolithic devices comprising independently selectable SPST switches which feature fast switching speeds (HI-200 240ns, and HI-201 185ns) combined with low power dissipation (15mW at 25<sup>o</sup>C). Each switch provides low "ON" resistance operation for input signal voltage up to the supply rails and for signal current up to 80mA. Rugged DI construction eliminates latch-up and substrate SCR failure modes.

All devices provide break-before-make switching and are TTL and CMOS compatible for maximum application versatility. HI-200/HI-201 are ideal components for use in high frequency analog switching. Typical applications include signal path switching, sample and hold circuit, digital filters, and operational amplifier gain switching networks.

# **Ordering Information**

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. DWG. #
HI3-0200-5Z (Note) (No longer available or supported)	0 to 75	14 Ld PDIP* (Pb-free)	E14.3
HI1-0201-2	-55 to 125	16 Ld CERDIP	F16.3
HI3-0201-5Z (Note)	0 to 75	16 Ld PDIP* (Pb-free)	E16.3
HI4P0201-5Z (Note) (No longer available or supported)	0 to 75	20 Ld PLCC (Pb-free)	N20.35
HI9P0201-5Z (Note)	0 to 75	16 Ld SOIC (Pb-free)	M16.15
HI9P0201-9Z (Note)	-40 to 85	16 Ld SOIC (Pb-free)	M16.15

\*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

NOTE: Intersil Pb-free products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020. Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

# Features

- Pb-Free Available (RoHS Compliant)

- TTL/CMOS Compatible

# Applications

- High Frequency Analog Switching
- Sample and Hold Circuits
- Digital Filters
- Operational Amplifier Gain Switching Networks

# Functional Diagram



### TRUTH TABLE

LOGIC	HI-200	HI-201
0	ON	ON
1	OFF	OFF

### **Pinouts** (Switches Shown For Logic "1" Input)





# Schematic Diagrams

TTL/CMOS REFERENCE CIRCUIT V<sub>REF</sub> CELL HI-200



TTL/CMOS REFERENCE CIRCUIT V<sub>REF</sub> CELL HI-201



# Schematic Diagrams (Continued)

SWITCH CELL







### **Absolute Maximum Ratings**

Supply Voltage (V+ to V-)	44V (±22)
V <sub>REF</sub> to Ground	20V, -5V
Digital Input Voltage (V+)	+4V to (V-) -4V
Analog Input Voltage (One Switch) (V+)	+2V to (V-) -2V

### **Operating Conditions**

#### Temperature Ranges

HI-201-2	-55°C to 125°C
HI-201-4	25°C to 85°C
HI-200-5, HI-201-5	
HI-201-9	40 <sup>o</sup> C to 85 <sup>o</sup> C

### **Thermal Information**

Thermal Resistance (Typical, Note 1)	$\theta_{JA}$ (°C/W)	$\theta_{JC}$ (°C/W)
CERDIP Package	75	20
PLCC Package	80	N/A
PDIP Package*	95	N/A
SOIC Package	110	N/A
Maximum Storage Temperature		5 <sup>0</sup> C to 150 <sup>0</sup> C
Maximum Junction Temperature (Hermetic	Packages).	175 <sup>0</sup> C
Maximum Junction Temperature (Plastic P	ackages)	150 <sup>0</sup> C
Maximum Lead Temperature (Soldering, 1	0s)	300 <sup>0</sup> C
(PLCC and SOIC - Lead Tips Only)		

\*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in reflow solder processing applications.

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTE:

1.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

	TEST CONDITIONS	TEMP ( <sup>o</sup> C)	-2		-4, -5, -9				
PARAMETER			MIN	TYP	MAX	MIN	TYP	MAX	UNITS
DYNAMIC CHARACTERISTICS									
Switch ON Time, t <sub>ON</sub>									
HI-200		25	-	240	500	-	240	-	ns
HI-201		25	-	185	500	-	185	-	ns
		Full	-	1000	-	-	1000	-	ns
Switch OFF Time, t <sub>OFF</sub>									
HI-200		25	-	330	500	-	500	-	ns
HI-201		25	-	220	500	-	220	-	ns
		Full	-	1000	-	-	1000	-	ns
Off Isolation	(Note 4)								
HI-200		25	-	70	-	-	70	-	dB
HI-201		25	-	80	-	-	80	-	dB
Input Switch Capacitance, CS(OFF)		25	-	5.5	-	-	5.5	-	pF
Output Switch Capacitance, C <sub>D(OFF)</sub>		25	-	5.5	-	-	5.5	-	pF
Output Switch Capacitance, C <sub>D(ON)</sub>		25	-	11	-	-	11	-	pF
Digital Input Capacitance, C <sub>A</sub>		25	-	5	-	-	5	-	pF
Drain-to-Source Capacitance, C <sub>DS(OFF)</sub>		25	-	0.5	-	-	0.5	-	pF
DIGITAL INPUT CHARACTERISTICS	l				1	1		1	L.
Input Low Threshold, VAL		Full	-	-	0.8	-	-	0.8	V
Input High Threshold, VAH		Full	2.4	-	-	2.4	-	-	V
Input Leakage Current (High or Low), IA	(Note 3)	Full	-	-	1.0	-	-	1.0	μA
ANALOG SWITCH CHARACTERISTICS	<b>j</b>								
Analog Signal Range, V <sub>S</sub>		Full	-15	-	+15	-15	-	+15	V
ON Resistance, r <sub>ON</sub>	(Note 2)	25	-	55	70	-	55	80	Ω
		Full	-	80	100	-	72	100	Ω

	TEST CONDITIONS	TEMP ( <sup>o</sup> C)	-2			-4, -5, -9			
PARAMETER			MIN	TYP	MAX	MIN	TYP	MAX	UNITS
OFF Input Leakage Current, IS(OFF)	(Note 6)	25	-	1	5	-	1	50	nA
HI-200		Full	-	100	500	-	10	500	nA
HI-201		25	-	2	5	-	2	50	nA
		Full	-	-	500	I	-	250	nA
OFF Output Leakage Current, I <sub>D(OFF)</sub>	(Note 6)	25	-	1	5	-	1	50	nA
HI-200		Full	-	100	500	-	10	500	nA
HI-201		25	-	2	5	-	2	50	nA
		Full	-	35	500	-	35	250	nA
ON Leakage Current, I <sub>D(ON)</sub>	(Note 6)	25	-	1	5	-	1	50	nA
HI-200		Full	-	100	500	-	10	500	nA
HI-201	-	25	-	2	5	-	2	50	nA
		Full	-	-	500	-	-	250	nA
POWER SUPPLY CHARACTERISTICS	(Note 5)								
Power Dissipation, PD		25	-	15	-	-	15	-	mW
		Full	-	-	60	-	-	60	mW
Current, I+		25	-	0.5	-	-	0.5	-	mA
		Full	-	-	2.0	-	-	2.0	mA
Current, I-		25	-	0.5	-	-	0.5	-	mA
		Full	-	-	2.0	-	-	2.0	mA

**Electrical Specifications** Supplies = +15V, -15V; V<sub>REF</sub> = Open; V<sub>AH</sub> (Logic Level High) = 2.4V, VAL (Logic Level Low) = 0.8V (Continued)

NOTES:

2.  $V_{OUT}$  = ±10V,  $I_{OUT}$  = 1mA.

3. Digital Inputs are MOS gates: typical leakage is < 1nA.

4.  $V_A$  = 5V,  $R_L$  = 1k $\Omega$ ,  $C_L$  = 10pF,  $V_S$  = 3V<sub>RMS</sub>, f = 100kHz.

5.  $V_A$  = +3V or  $V_A$  = 0V for Both Switches.

6. Refer to Leakage Current Measurements (Figure 2).

**Test Circuits and Waveforms** T<sub>A</sub> = 25°C, V<sub>SUPPLY</sub> =  $\pm\pm$ 15V, V<sub>AH</sub> = 2.4V, V<sub>AL</sub> = 0.8V and V<sub>REF</sub> = Open



FIGURE 1A. ON RESISTANCE TEST CIRCUIT



FIGURE 3A. SWITCH CURRENT vs VOLTAGE



**FIGURE 3. SWITCH CURRENT** 



For more information see Application Notes AN520, AN521, AN531, AN532 and AN557.

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# **Application Information**

### Single Supply Operation

The switch operation of the HI-200/201 is dependent upon an internally generated switching threshold voltage optimized for  $\pm 15$ V power supplies. The HI-200/201 does not provide the necessary internal switching threshold in a single supply system. Therefore, if single supply operation is required, the HI-300 series of switches is recommended. The HI-300 series will remain operational to a minimum +5V single supply.

Switch performance will degrade as power supply voltage is reduced from optimum levels ( $\pm$ 15V). So it is recommended that a single supply design be thoroughly evaluated to ensure that the switch will meet the requirements of the application.

For further information see Application Notes AN520, AN557, AN1033 and AN1034.

# **Die Characteristics**

### **METALLIZATION:**

Type: CuAl Thickness: 16kÅ ±2kÅ

### PASSIVATION:

Type: Nitride over Silox Nitride Thickness: 3.5kÅ ±1kÅ Silox Thickness: 12kÅ ±2kÅ

### WORST CASE CURRENT DENSITY:

2 x 10<sup>5</sup> A/cm<sup>2</sup> at 25mA

# Metallization Mask Layout



### **Die Characteristics**

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 $2 \times 10^5 \text{ A/cm}^2$  at 25 mA



# Metallization Mask Layout

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# **Revision History**

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

DATE	REVISION	CHANGE
September 15, 2015	FN3121.9	<ul> <li>Updated Ordering Information Table on page 1.</li> <li>Added Revision History.</li> <li>Added About Intersil Verbiage.</li> </ul>

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